

Main Product Characteristics:

V _{DSS}	20V	oii E	D1 =	
R _{DS} (on)	16.5mohm(typ.)	Skirron	SSF2816E TO S	2 ↓ ∐ T
I _D	7A	TSSOP-8	Marking and pin	Schematic diagram
		10001-0	Assignment	ochemate diagram

Features and Benefits:

- Advanced MOSFET process technology
- Special designed for PWM, load switching and general purpose applications
- Ultra low on-resistance with low gate charge
- Fast switching and reverse body recovery
- 150°C operating temperature
- 2KV ESD Protected



Description:

It utilizes the latest processing techniques to achieve the high cell density and reduces the on-resistance with high repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications

Absolute max Rating:

Symbol	Parameter	Max.	Units
I _D @ TC = 25°C	Continuous Drain Current, V _{GS} @ 10V①	7	А
I _{DM}	Pulsed Drain Current②	25	A
P _D @TC = 25°C	Power Dissipation③	1.5	W
V _{DS}	Drain-Source Voltage	20	V
V _{GS}	Gate-to-Source Voltage	± 12	V
T _J T _{STG}	Operating Junction and Storage Temperature Range	-55 to +150	°C

Thermal Resistance

Symbol	Characterizes	Тур.	Max.	Units
$R_{\theta JA}$	Junction-to-ambient (t \leq 10s) (4)		83	°C/W





Electrical Characterizes $@T_A=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source breakdown voltage	20	_	_	V	V _{GS} = 0V, ID = 250μA
		_	16.5	22	mΩ	V_{GS} =4.5 V , I_{D} = 6.5 A
D	Static Drain-to-Source on-resistance	_	17	23		V_{GS} =4 V , I_D = 6 A
$R_{DS(on)}$	Static Dialif-to-Source off-resistance	_	19	26	11122	V_{GS} =3.1 V , I_{D} = 5.5 A
		_	22	30		$V_{GS}=2.5V, I_D=5.5A$
$V_{GS(th)}$	Gate threshold voltage	0.6	0.75	1.2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
I _{DSS}	Drain-to-Source leakage current	_	_	1	μΑ	$V_{DS} = 20V, V_{GS} = 0V$
1	Gate-to-Source forward leakage	_	_	±200	nA	$V_{GS}=\pm4.5V, V_{DS}=0V$
I _{GSS}	Gale-to-Source forward leakage	_	_	±10	uA	$V_{GS}=\pm 10V, V_{DS}=0V$
g FS	Forward Transconductance	_	6.6	_	S	V _{DS} =10V,I _D =6.5A
Qg	Total gate charge	_	10	15		V _{DS} =10V,
Q _{gs}	Gate-to-Source charge	_	2.3	_	nC	I _D =7A,
Q _{gd}	Gate-to-Drain("Miller") charge	_	3	_		V _{GS} =4.5V
t _{d(on)}	Turn-on delay time	_	10	20		
t _r	Rise time	_	11	25		V _{DD} =10V,I _D =1A
t _{d(off)}	Turn-Off delay time	_	35	70	ns	V_{GS} =4.5 V , R_{GEN} =6 Ω
t _f	Fall time	_	30	60		
C _{iss}	Input capacitance	_	600	_		$V_{GS} = 0V$
C _{oss}	Output capacitance	_	330	_	pF	$V_{DS} = 8V$
C _{rss}	Reverse transfer capacitance	_	140	_		f = 1.0MHz

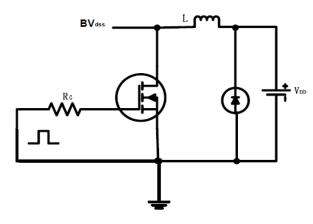
Source-Drain Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
	Continuous Source Current			7	^	MOSFET symbol
Is	(Body Diode)		,	A	showing the	
	Pulsed Source Current	ulsed Source Current		25	А	integral reverse
I _{SM}	(Body Diode)		_			p-n junction diode.
V_{SD}	Diode Forward Voltage	_	0.84	1.2	V	I _S =1.5A, V _{GS} =0V

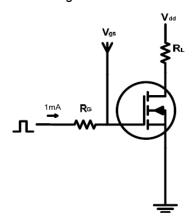


Test circuits and Waveforms

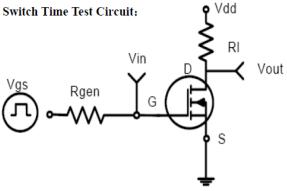
EAS test circuits:



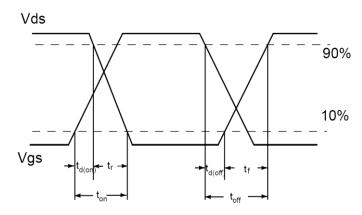
Gate charge test circuit:







Switch Waveforms:



Version: 1.2

Notes:

- ①Calculated continuous current based on maximum allowable junction temperature.
- ②Repetitive rating; pulse width limited by max. junction temperature.
- ③The power dissipation PD is based on max. junction temperature, using junction-to-case thermal resistance.
- ⑤ The value of R_{θJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C



Typical electrical and thermal characteristics

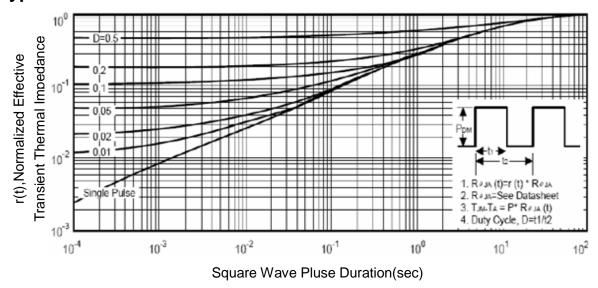
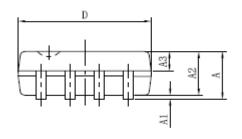


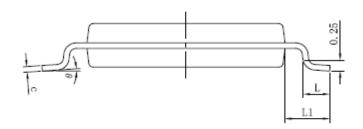
Figure 1 Normalized Maximum Transient Thermal Impedance

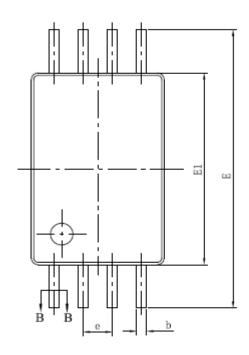


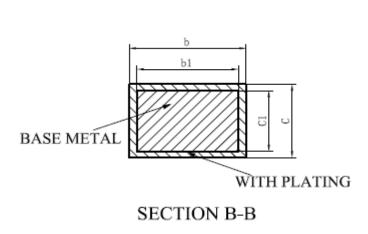
Mechanical Data:

TSSOP8 PACKAGE OUTLINE DIMENSION









Cumbal	Dimension I	n Millimeters	Dimension In Inches		
Symbol	Min	Max	Min	Max	
D	2.800	3.200	0.110	0.126	
Е	6.200	6.600	0.244	0.260	
b	0.210	0.280	0.008	0.011	
С	0.130	0.190	0.005	0.007	
E1	4.200	4.600	0.165	0.181	
Α	-	1.200	-	0.047	
A2	0.850	1.150	0.033	0.045	
A1	0.050	0.150	0.002	0.006	
е	0.65 (BSC)		0.026	(BSC)	
L	0.450	0.750	0.018	0.030	
Н	0.25	TYP	0.01	TYP	
θ	1 ⁰	8 ⁰	1 ⁰	8 ⁰	



Ordering and Marking Information

Device Marking: SSF2816E

Package (Available)
TSSOP-8
Operating Temperature Range
C: -55 to 150 °C

Devices per Unit

Package	Units/	Tapes/	Units/	Inner Boxes/	Units/
Туре	Tape	Inner Box	Inner Box	Carton Box	Carton Box
TSSOP-8	3000	2	6000	8	48000

Reliability Test Program

Test Item	Conditions	Duration	Sample Size
High	T _j =125℃ to 150℃ @	168 hours	3 lots x 77 devices
Temperature	80% of Max	500 hours	
Reverse	V _{DSS} /V _{CES} /VR	1000 hours	
Bias(HTRB)			
High	T _j =150℃ @ 100% of	168 hours	3 lots x 77 devices
Temperature	Max V _{GSS}	500 hours	
Gate		1000 hours	
Bias(HTGB)			



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